





STATE CENTER COMMUNITY COLLEGE DISTRICT

TECHNOLOGY MASTER PLAN PROJECT MEETING



Information Gathering

Initial Background Information Data Dump

- Current technology standards
- Existing cable infrastructure CAD drawings and construction documents
- Logical network design & as-built documentation

Discovery

- Electronic Questionnaires
- Site Visits
- Focus Group Discussion



Information Gathering (cont...)

Steering / Policy Committee (Provide oversight, leadership and direction on business objectives and priorities)

- Departmental leadership
- Project oversight
- Departmental coordination
- Budget & policy guidance
- Final review / comment on standards and construction documents

Technology Working Groups (Provide direction, technical and financial details, and other operational input)

- SCCCD & tk1sc subject matter experts (SME's)
- Discuss technology baselines
- Discuss technology issues, gaps, and priorities
- Review / comment on working drafts of standards and construction documents



Analysis & Prioritization

Current State
Where Are We Now?
Desired State
Where Do We Want To Go?

What are the SCCCD priorities? What Do We Need To Do Get There?



Recommendations & Consensus

Working Group Outputs

Recommendations for standards and technology updates Summarize findings into priority (High, Medium, Low) with respect to district goals and objectives

Department / Location: District Wide

Gap Analysis:

Existing fiber backbone does not support 100gb networking and on demand provisioning.

Recommendations:

Upgrade to single mode fiber backbone

Specify air blown fiber for new OSP projects.

Gap Analysis Me`tric	Met	Partially Met	Not Met	Strengths	Weaknesses
Upgrade district-wide campus telecom backbones.	Yes	-	-	Enables campus wi-fi upgrades	Dependency on new funding

CAMPUS DEMOGRAPHICS

of Buildings

of Users

CAMPUS SYSTEMS

Computer / Server / Storage

LAN

WAN

W-LAN

Voice

Network Security & Management

Tools

Cellular (DAS)

Security

Mass Notification

Cable Infrastructure

Inside Plant

Outside Plant

Fire and Life Safety

Battery Back Up













Project Deliverables

- Telecom Design Standards
- Construction Documents
 - 270000 General Requirements
 - 270200 Communications General Requirements
 - 270526 Grounding and Bonding for Communications Systems
 - 270528 Pathways for Communications Systems
 - 270537 Firestopping for Communications Systems
 - 271000 Structured Cabling Testing
 - 271100 Communications Equipment Room Fittings
 - 271200 Communications Building RF Specifications
 - 271300 Communications Copper Backbone Cabling
 - 271323 Communications Fiber Backbone Cabling
 - 271500 Communications Horizontal Cabling
 - 271600 Communications Connection Cords
 - 271000 Data Communications Network Equipment
 - 272200 Data Communications Hardware
 - 273000 Voice Communications
 - 283100 Mass Notification
 - 281300 Access Control / Intrusion Detection
 - 282300 Video Surveillance

SCCCD Technology Master Plan Timeline



April 4- May 21 - 33 days INFORMATION GATHERING / DISCOVERY

May 1 Begin On-Site Meetings

May 21- July 27 -45 days - ANALYSIS & RECOMMENDATIONS

July 27 Deliver Tech Gap Analysis & Recommendations

July 30 - Aug 17 - 14 days SCCCD PRIORITIZATION

Aug 20- Oct 1 30 days STANDARDS DOCUMENTATION DEVELOPMENT

Sep 1 Deliver 1st Drafts

TELECOM DESIGN STANDARDS OUTLINE

EXECUTIVE SUMMARY

1.	Executive Summary
2.	Introduction
2.1	Responsibilities Of SCCCD District IS Department
2.2	Architect Responsibilities
2.3	Scope Of Work Matrix To Be Included In District Projects
2.4	Telecommunication Consultant/Designer Role
2.5	Telecommunication Design Approach
2.5.1	Rooms, Routes & Risers
2.5.2	Common Cabling Infrastructure
2.5.3	Equipment & Systems – Logical Design

ARCHITECTURAL

3.	Architectural
3.1	Campus Information Technology Rooms, Functions
3.1.1	Main Distribution Frame (MDF
3.1.2	Building Telecommunications Room (BDF)
3.1.3	Telecommunications Rooms (TR)
3.1.4	Non-Information Technology Systems
3.2	Campus Information Technology Room Locations
3.2.1	General
3.2.2	Building Telecommunications Room (BDF)
3.2.3	Telecommunications Rooms (TR)
3.3	Information Technology Room Sizing
3.3.1	General
3.3.2	Building Telecommunications Room (BDF)
3.3.3	Telecommunications Rooms (TR)
3.4	Lighting
3.5	Water Infiltration

ARCHITECTURAL (continued)

3.6	Floor
3.6.1	General Floor Design Elements
3.6.2	Loading
3.7	Sprinklers/Fire Suppression
3.7.1	Sprinklers
3.7.2	Fire Suppression Systems
3.8	Doors
3.9	Interior Finishes
3.9.1	Walls
3.9.2	Ceilings
3.9.3	Clearance
3.9.4	Security
3.10	Information Technology Rooms Construction Sequence
3.11	Special Design Considerations
3.11.1	Building Fire Rated Barriers
3.11.2	Cable Support (General)
3.11.3	Slab On Grade

ARCHITECTURAL (continued)

3.12	Work Area Telecommunication Outlet
3.12.1	General
3.12.2	Single-Person Office
3.12.3	Conference Rooms
3.12.4	Instructional Classrooms
3.12.5	Cubicle/Partitioned Offices (Modular Furniture)
3.12.6	Floors
3.12.7	Wall Mounted Telephones/Payphones/Text Telephones
3.12.8	Work Rooms
3.12.9	Computer Labs
3.12.10	Specialty Locations
3.12.11	Maintenance Spaces
3.12.12	Building Rooftops
3.12.13	Storage Areas
3.12.14	Wireless And Projector Support
3.13	Outside Plant (General)
3.13.1	Campus Environments
3.13.2	Renovation Projects
3.14	Construction Documents

ELECTRICAL

4.1	General Power Requirements
4.2	Telecommunication Room Power Requirements
4.2.1	General
4.3	Electromagnetic Interference
4.4	Generator/Ups
4.5	Grounding
4.6	Raised Floor Bonding And Grounding
4.7	Terminal Board
4.8	Communication Pathways
4.9	Fire Stop Penetrations
4.10	Communication Outlets
4.10.1	Communication Outlets
4.10.2	Outlet Location Considerations
4.10.3	Outlet Boxes
4.11	Floor Boxes
4.12	Wireless Access Points (WAP) And Projector Support
4.13	Communication/Power Raceways
4.14	Floor Poke-Throughs
4.15	Building Rooftops

ELECTRICAL (continued)

4.16 Inside Conduits (General)
4.17 Communications Cable Tray
4.18 Communications J-Hooks
4.19 Pull Boxes
4.20 Underground Conduits
4.21 Equipment Specifications

MECHANICAL (Hvac)

- 5.1 General
- **5.2** Thermal Dissipation
- **5.3** Coordination With Maintenance And Operations

CIVIL (Outside Plant)

6.1	General
6.2	Underground Conduits
6.3	Conduits/Duct Banks
6.4	Communication Maintenance Holes/ Hand-Holes Sizes
6.5	Communication Maintenance Holes/ Hand-Holes Locations

TELECOMMUNICATION

7.1	Telecommunication Consultant
7.2	SCCCD Product Standards
7.3	Outside Plant
7.3.1	OSP Design Activities
7.3.2	Outside Plant Fiber Optic Cables
7.3.3	Tube Cabling
7.3.4	OSP Fiber Optic Cable Sizing
7.3.5	General Installation Guidelines For Optical Fiber Cables
7.3.6	Copper Outside Plant Cables
7.3.7	General Installation Guidelines For Copper Cables
7.3.8	Copper Protection
7.4	Riser Segment
7.4.1	Fiber Optic Riser Cable
7.4.2	Riser Tube Cable
7.4.3	Copper Riser Cable
7.4.4	Coaxial Riser Cable
7.5	Optical Fiber Terminations
7.5.1	Fiber Patch Panels
7.5.2	Optical Fiber Connectors

TELECOMMUNICATION (continued)

7.6	Copper Punch Down Blocks
7.7	Horizontal Station Cable
7.8	Voice/Data Jacks
7.9	Work Area Outlets
7.10	Outlet Distribution
7.11	Faceplates
7.12	Copper Patch Panels
7.13	Grounding And Bonding
7.14	Rack/Cabinet Layout (Elevation)
7.15	Floor Mounted Racks
7.16	Floor Mounted Cabinets
7.17	Cable Wire Management
7.18	Cable Runway
7.19	Cable Pathways
7.20	Cable Installation Methods
7.21	Fiber Optic Cable Testing And Test Results
7.22	Backbone Copper Cable Testing And Test Results

TELECOMMUNICATION (continued)

- 7.23 Utp Horizontal Cable Testing And Test Results
- 7.24 Cable Testing Validation
- 7.25 Identification And Labeling
- 7.26 Role Of District IS
- 7.27 Inspection
- 8. Codes, Standards And References
- 9. Sample Specifications